



Technologies Enabling Smart Grid in Distribution Networks and Microgrids 2.0

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Message from the Guest Editors

The aim of this Special Issue is to investigate emerging technologies, which are required in the design and implementation of future smart grids.

This issue welcomes theoretical papers, methodological studies, and empirical research on the design and implementation of smart grids, concerning (but not limited to) the application of: Information and communication technologies, smart meters and sensors, phasor measurement units, innovative protection and control systems, energy management systems for active networks, microgrids, and e-mobility, and systems and frameworks for demand response management.





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